

# RF Power LDMOS Transistor

## High Ruggedness N-Channel Enhancement-Mode Lateral MOSFET

Designed for mobile two-way radio applications with frequencies from 136 to 941 MHz. The high gain, ruggedness and wideband performance of this device make it ideal for large-signal, common-source amplifier applications in mobile radio equipment.

### Narrowband Performance (12.5 Vdc, I<sub>DQ</sub> = 100 mA, T<sub>A</sub> = 25°C, CW)

| Frequency (MHz)    | G <sub>ps</sub> (dB) | η <sub>D</sub> (%) | P <sub>out</sub> (W) |
|--------------------|----------------------|--------------------|----------------------|
| 870 <sup>(1)</sup> | 17.2                 | 77.0               | 16                   |

### Wideband Performance (12.5 Vdc, T<sub>A</sub> = 25°C, CW)

| Frequency (MHz)        | P <sub>in</sub> (W) | G <sub>ps</sub> (dB) | η <sub>D</sub> (%) | P <sub>out</sub> (W) |
|------------------------|---------------------|----------------------|--------------------|----------------------|
| 136-174                | 0.38                | 16.0                 | 60.0               | 15                   |
| 350-470                | 0.23                | 18.5                 | 60.0               | 16                   |
| 760-870 <sup>(2)</sup> | 0.32                | 16.8                 | 52.3               | 15                   |

### Load Mismatch/Ruggedness

| Frequency (MHz)    | Signal Type | VSWR                       | P <sub>in</sub> (W)  | Test Voltage | Result                |
|--------------------|-------------|----------------------------|----------------------|--------------|-----------------------|
| 870 <sup>(1)</sup> | CW          | > 65:1 at all Phase Angles | 0.5 (3 dB Overdrive) | 17           | No Device Degradation |

1. Measured in 870 MHz narrowband test circuit.
2. Measured in 760-870 MHz UHF broadband reference circuit.

### Features

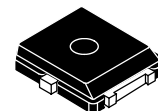
- Characterized for Operation from 136 to 941 MHz
- Unmatched Input and Output Allowing Wide Frequency Range Utilization
- Integrated ESD Protection
- Integrated Stability Enhancements
- Wideband — Full Power Across the Band
- Exceptional Thermal Performance
- Extreme Ruggedness
- High Linearity for: TETRA, SSB
- In Tape and Reel. T1 Suffix = 1,000 Units, 16 mm Tape Width, 7-inch Reel.

### Typical Applications

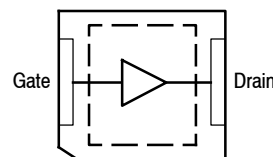
- Output or Driver Stage VHF Band Mobile Radio
- Output or Driver Stage UHF Band Mobile Radio
- Output or Driver Stage for 700-800 MHz Mobile Radio

**AFT09MS015NT1**

**136-941 MHz, 16 W, 12.5 V  
 WIDEBAND  
 RF POWER LDMOS TRANSISTOR**



**PLD-1.5W**



Note: The center pad on the backside of the package is the source terminal for the transistor.

**Figure 1. Pin Connections**

**Table 1. Maximum Ratings**

| Rating   | Symbol    | Value       | Unit      |
|--|-----------|-------------|-----------|
| Drain-Source Voltage   | $V_{DSS}$ | -0.5, +40   | Vdc       |
| Gate-Source Voltage  | $V_{GS}$  | -6.0, +12   | Vdc       |
| Operating Voltage  | $V_{DD}$  | 17, +0      | Vdc       |
| Storage Temperature Range  | $T_{stg}$ | -65 to +150 | °C        |
| Case Operating Temperature Range   | $T_C$     | -40 to +150 | °C        |
| Operating Junction Temperature (1,2)   | $T_J$     | -40 to +150 | °C        |
| Total Device Dissipation @ $T_C = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$     | 125<br>1.0  | W<br>W/°C |

**Table 2. Thermal Characteristics**

| Characteristic  | Symbol          | Value (2,3) | Unit |
|---|-----------------|-------------|------|
| Thermal Resistance, Junction to Case<br>Case Temperature $85^\circ\text{C}$ , 15 W CW, 12.5 Vdc, $I_{DQ} = 100\text{ mA}$ , 870 MHz | $R_{\theta JC}$ | 1.0         | °C/W |

**Table 3. ESD Protection Characteristics**

| Test Methodology                      | Class             |
|---------------------------------------|-------------------|
| Human Body Model (per JESD22-A114)    | 2, passes 2500 V  |
| Machine Model (per EIA/JESD22-A115)   | A, passes 150 V   |
| Charge Device Model (per JESD22-C101) | IV, passes 2000 V |

**Table 4. Moisture Sensitivity Level**

| Test Methodology                     | Rating | Package Peak Temperature | Unit |
|--------------------------------------|--------|--------------------------|------|
| Per JESD22-A113, IPC/JEDEC J-STD-020 | 3      | 260                      | °C   |

**Table 5. Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

**Off Characteristics**

|   |           |   |   |     |                 |
|---|-----------|---|---|-----|-----------------|
| Zero Gate Voltage Drain Leakage Current<br>( $V_{DS} = 40\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ )   | $I_{DSS}$ | — | — | 10  | $\mu\text{Adc}$ |
| Zero Gate Voltage Drain Leakage Current<br>( $V_{DS} = 12.5\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ ) | $I_{DSS}$ | — | — | 2   | $\mu\text{Adc}$ |
| Gate-Source Leakage Current<br>( $V_{GS} = 5\text{ Vdc}$ , $V_{DS} = 0\text{ Vdc}$ )                | $I_{GSS}$ | — | — | 600 | nAdc            |

**On Characteristics**

|  |              |     |      |     |     |
|--|--------------|-----|------|-----|-----|
| Gate Threshold Voltage<br>( $V_{DS} = 10\text{ Vdc}$ , $I_D = 78\ \mu\text{Adc}$ ) | $V_{GS(th)}$ | 1.8 | 2.2  | 2.6 | Vdc |
| Drain-Source On-Voltage<br>( $V_{GS} = 10\text{ Vdc}$ , $I_D = 0.78\text{ Adc}$ )  | $V_{DS(on)}$ | —   | 0.15 | —   | Vdc |
| Forward Transconductance<br>( $V_{DS} = 10\text{ Vdc}$ , $I_D = 5.9\text{ Adc}$ )  | $g_{fs}$     | —   | 4.4  | —   | S   |

**Dynamic Characteristics**

|   |           |   |      |   |    |
|---|-----------|---|------|---|----|
| Reverse Transfer Capacitance<br>( $V_{DS} = 12.5\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$ ) | $C_{rss}$ | — | 1.04 | — | pF |
| Output Capacitance<br>( $V_{DS} = 12.5\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$ )           | $C_{oss}$ | — | 34   | — | pF |
| Input Capacitance<br>( $V_{DS} = 12.5\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz)            | $C_{iss}$ | — | 74   | — | pF |

1. Continuous use at maximum temperature will affect MTTF.
2. MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.
3. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

(continued)

**AFT09MS015NT1**

**Table 5. Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted) **(continued)**

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

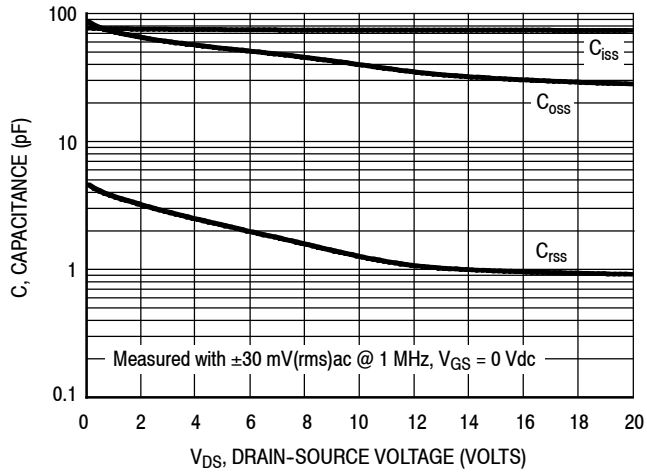
**Functional Tests** (In Freescale Test Fixture, 50 ohm system)  $V_{DD} = 12.5\text{ Vdc}$ ,  $I_{DQ} = 100\text{ mA}$ ,  $P_{in} = 0.3\text{ W}$ ,  $f = 870\text{ MHz}$

|                                      |           |   |      |   |   |
|--------------------------------------|-----------|---|------|---|---|
| Common-Source Amplifier Output Power | $P_{out}$ | — | 16.0 | — | W |
| Drain Efficiency                     | $\eta_D$  | — | 77.0 | — | % |

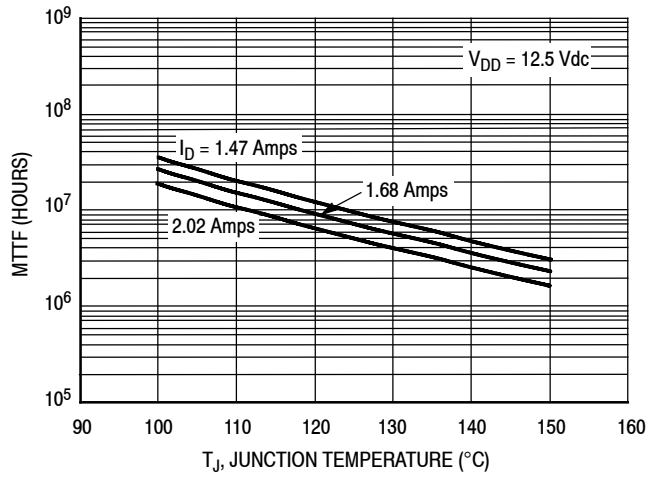
**Load Mismatch/Ruggedness** (In Freescale Test Fixture, 50 ohm system)  $I_{DQ} = 100\text{ mA}$

| Frequency (MHz) | Signal Type | VSWR                       | $P_{in}$ (W)            | Test Voltage, $V_{DD}$ | Result                |
|-----------------|-------------|----------------------------|-------------------------|------------------------|-----------------------|
| 870             | CW          | > 65:1 at all Phase Angles | 0.5<br>(3 dB Overdrive) | 17                     | No Device Degradation |

### TYPICAL CHARACTERISTICS



**Figure 2. Capacitance versus Drain-Source Voltage**

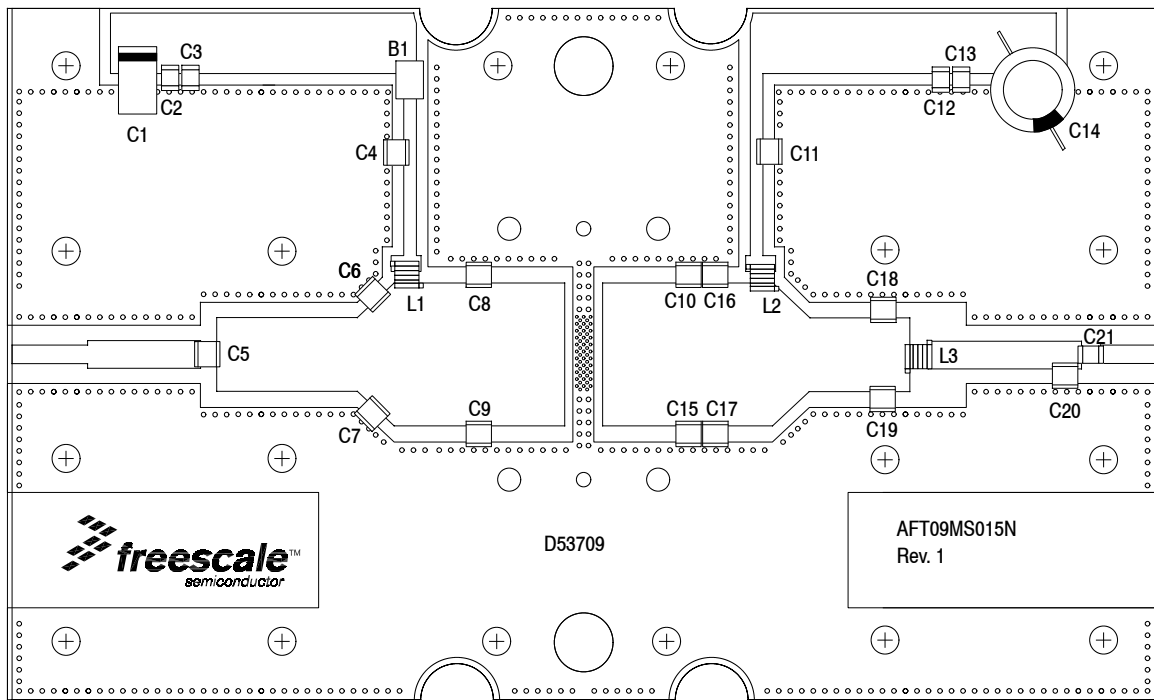


**Note:** MTTF value represents the total cumulative operating time under indicated test conditions.

MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.

**Figure 3. MTTF versus Junction Temperature — CW**

## 870 MHz NARROWBAND PRODUCTION TEST FIXTURE



**Figure 4. AFT09MS015NT1 Narrowband Test Circuit Component Layout — 870 MHz**

**Table 6. AFT09MS015NT1 Narrowband Test Circuit Component Designations and Values — 870 MHz**

| Part       | Description                                 | Part Number          | Manufacturer |
|------------|---|----------------------|--------------|
| B1         | RF Bead, Short                              | 2743019447           | Fair-Rite    |
| C1         | 22 $\mu$ F, 35 V Tantalum Capacitor         | T491X226K035AT       | Kemet        |
| C2, C13    | 0.1 $\mu$ F Chip Capacitors                 | CDR33BX104AKWS       | AVX          |
| C3, C12    | 0.01 $\mu$ F Chip Capacitors                | C0805C103K5RAC       | Kemet        |
| C4, C11    | 56 pF Chip Capacitors                       | ATC100B560CT500XT    | ATC          |
| C5, C8, C9 | 5.6 pF Chip Capacitors                      | ATC100B5R6CT500XT    | ATC          |
| C6, C7     | 3.3 pF Chip Capacitors                      | ATC100B3R3CT500XT    | ATC          |
| C14        | 330 $\mu$ F, 35 V Electrolytic Capacitor    | MCGPR35V337M10X16-RH | Multicomp    |
| C15, C10   | 9.1 pF Chip Capacitors                      | ATC100B9R1CT500XT    | ATC          |
| C16, C17   | 7.5 pF Chip Capacitors                      | ATC100B7R5CT500XT    | ATC          |
| C18, C19   | 6.2 pF Chip Capacitors                      | ATC100B6R2BT500XT    | ATC          |
| C20        | 1.5 pF Chip Capacitor                       | ATC100B1R5BT500XT    | ATC          |
| C21        | 3.9 pF Chip Capacitor                       | ATC100B3R9CT500XT    | ATC          |
| L1         | 5.0 nH, 2 Turn Inductor                     | A02TKLC              | Coilcraft    |
| L2         | 8.0 nH, 3 Turn Inductor                     | A03TKLC              | Coilcraft    |
| L3         | 2.5 nH, 1 Turn Inductor                     | A01TKLC              | Coilcraft    |
| PCB        | Rogers RO4350B, 0.030", $\epsilon_r = 3.66$ | D53709               | MTL          |

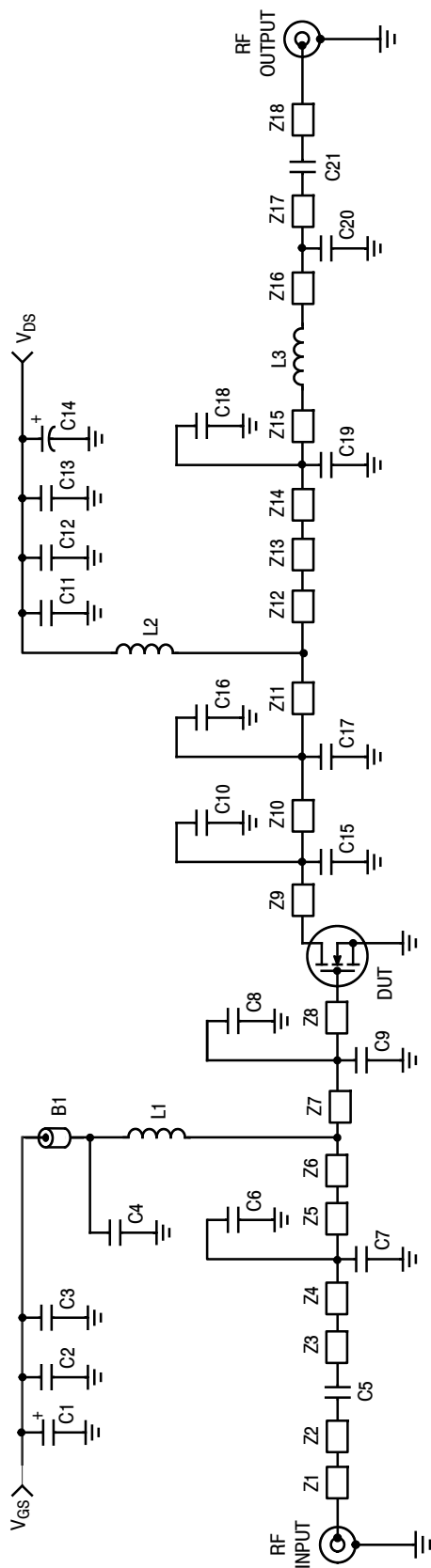
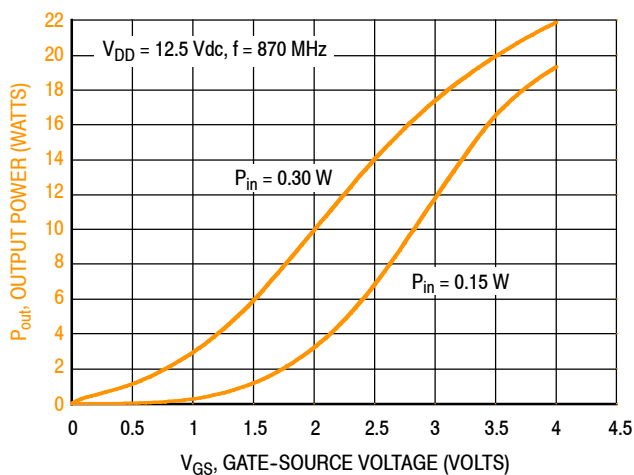


Figure 5. AFT09MS015NT1 Narrowband Test Circuit Schematic — 870 MHz

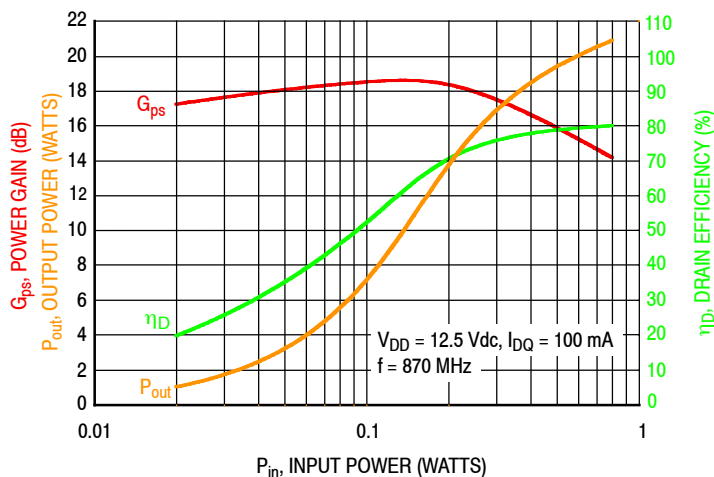
Table 7. AFT09MS015NT1 Narrowband Test Circuit Microstrips — 870 MHz

| Microstrip | Description                    |
|------------|--------------------------------|
| Z1         | 0.328" x 0.080" Microstrip     |
| Z2         | 0.490" x 0.120" Microstrip     |
| Z3         | 0.610" x 0.320" Microstrip     |
| Z4         | 0.107" x 0.320" x 0.466" Taper |
| Z5         | 0.082" x 0.466" x 0.620" Taper |
| Z6         | 0.070" x 0.620" Microstrip     |
| Z7         | 0.300" x 0.620" Microstrip     |
| Z8         | 0.370" x 0.620" Microstrip     |
| Z9         | 0.375" x 0.620" Microstrip     |
| Z10        | 0.120" x 0.620" Microstrip     |
| Z11        | 0.198" x 0.320" Microstrip     |
| Z12        | 0.044" x 0.320" Microstrip     |
| Z13        | 0.159" x 0.620" x 0.320" Taper |
| Z14        | 0.320" x 0.320" Microstrip     |
| Z15        | 0.113" x 0.320" Microstrip     |
| Z16        | 0.599" x 0.120" Microstrip     |
| Z17        | 0.071" x 0.120" Microstrip     |
| Z18        | 0.238" x 0.080" Microstrip     |

### TYPICAL CHARACTERISTICS — 870 MHz



**Figure 6. Output Power versus Gate-Source Voltage at a Constant Input Power**



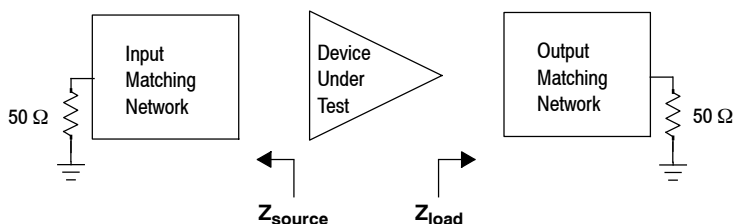
**Figure 7. Power Gain, Output Power and Drain Efficiency versus Input Power**

$V_{DD} = 12.5 \text{ Vdc}$ ,  $I_{DQ} = 100 \text{ mA}$ ,  $P_{out} = 15 \text{ W}$

| f<br>MHz | $Z_{source}$<br>Ω | $Z_{load}$<br>Ω |
|----------|-------------------|-----------------|
| 870      | $0.80 + j0.80$    | $2.05 + j1.80$  |

$Z_{source}$  = Test circuit impedance as measured from gate to ground.

$Z_{load}$  = Test circuit impedance as measured from drain to ground.



**Figure 8. Narrowband Series Equivalent Source and Load Impedance — 870 MHz**

## 760-870 MHz UHF BROADBAND REFERENCE CIRCUIT

**Table 8. 760-870 MHz UHF Broadband Performance** (In Freescale Reference Circuit, 50 ohm system)

$V_{DD} = 12.5$  Volts,  $I_{DQ} = 100$  mA,  $T_A = 25^\circ\text{C}$ , CW

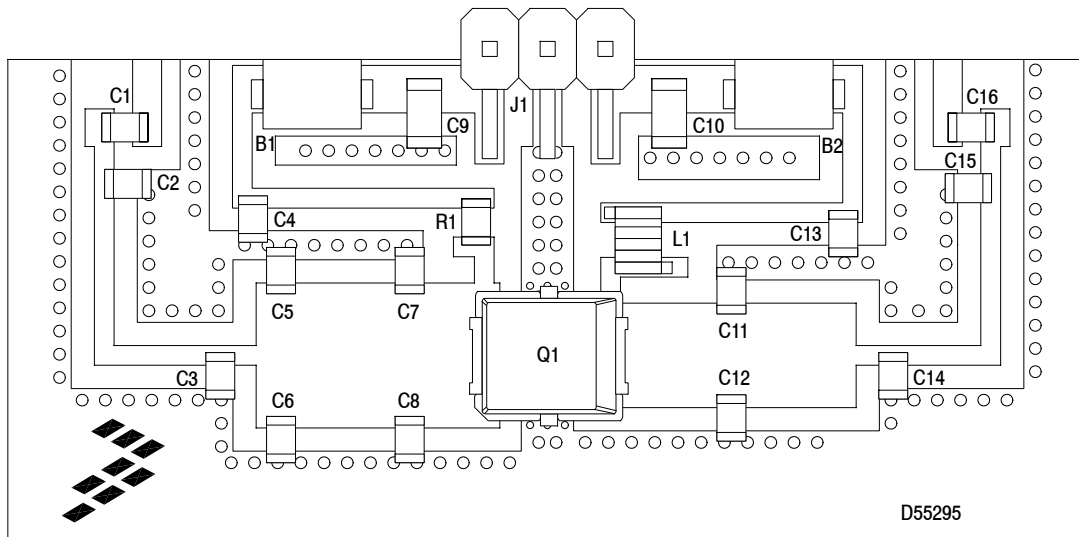
| Frequency (MHz) | $P_{in}$ (W) | $G_{ps}$ (dB) | $\eta_D$ (%) | $P_{out}$ (W) |
|-----------------|--------------|---------------|--------------|---------------|
| 760             | 0.29         | 17.1          | 51.1         | 15.0          |
| 815             | 0.24         | 18.0          | 57.7         | 15.0          |
| 870             | 0.30         | 17.0          | 59.2         | 15.0          |

**Table 9. Load Mismatch/Ruggedness** (In Freescale Reference Circuit)

| Frequency (MHz) | Signal Type | VSWR                       | $P_{in}$ (W)             | Test Voltage, $V_{DD}$ | Result                |
|-----------------|-------------|----------------------------|--------------------------|------------------------|-----------------------|
| 815             | CW          | > 65:1 at all Phase Angles | 0.64<br>(3 dB Overdrive) | 15                     | No Device Degradation |



## 760-870 MHz UHF BROADBAND REFERENCE CIRCUIT



**Figure 9. AFT09MS015NT1 UHF Broadband Reference Circuit Component Layout — 760-870 MHz**

**Table 10. AFT09MS015NT1 UHF Broadband Reference Circuit Component Designations and Values — 760-870 MHz**

| Part               | Description                            | Part Number        | Manufacturer |
|--------------------|--|--------------------|--------------|
| B1, B2             | RF Beads                               | 2743019447         | Fair-Rite    |
| C1, C5, C6, C7, C8 | 20 pF Chip Capacitors                  | GQM2195C2E200GB12D | Murata       |
| C2                 | 8.2 pF Chip Capacitor                  | GQM2195C2E8R2BB12D | Murata       |
| C3                 | 10 pF Chip Capacitor                   | GQM2195C2E100FB12D | Murata       |
| C4, C13            | 56 pF Chip Capacitors                  | GQM2195C2E560GB12D | Murata       |
| C9                 | 1 $\mu$ F Chip Capacitor               | GRM31MR71H105KA88L | Murata       |
| C10                | 10 $\mu$ F Chip Capacitor              | GRM31CR61H106KA12L | Murata       |
| C11, C12           | 12 pF Chip Capacitors                  | GQM2195C2E120FB12D | Murata       |
| C14, C15           | 5.6 pF Chip Capacitors                 | GQM2195C2E5R6BB12D | Murata       |
| C16                | 100 pF Chip Capacitor                  | GQM2195C2E101GB12D | Murata       |
| J1                 | Right-Angle Breakaway Headers (3 pins) | 22-28-8360         | Molex        |
| L1                 | 22 nH Air Core Inductor                | 0908SQ-22NJL       | Coilcraft    |
| Q1                 | RF Power LDMOS Transistor              | AFT09MS015NT1      | Freescale    |
| R1                 | 200 $\Omega$ , 1/8 W Chip Resistor     | CRCW0805200RJNEA   | Vishay       |
| PCB                | 0.020", $\epsilon_r = 4.8$ , FR4       | D55295             | MTL          |

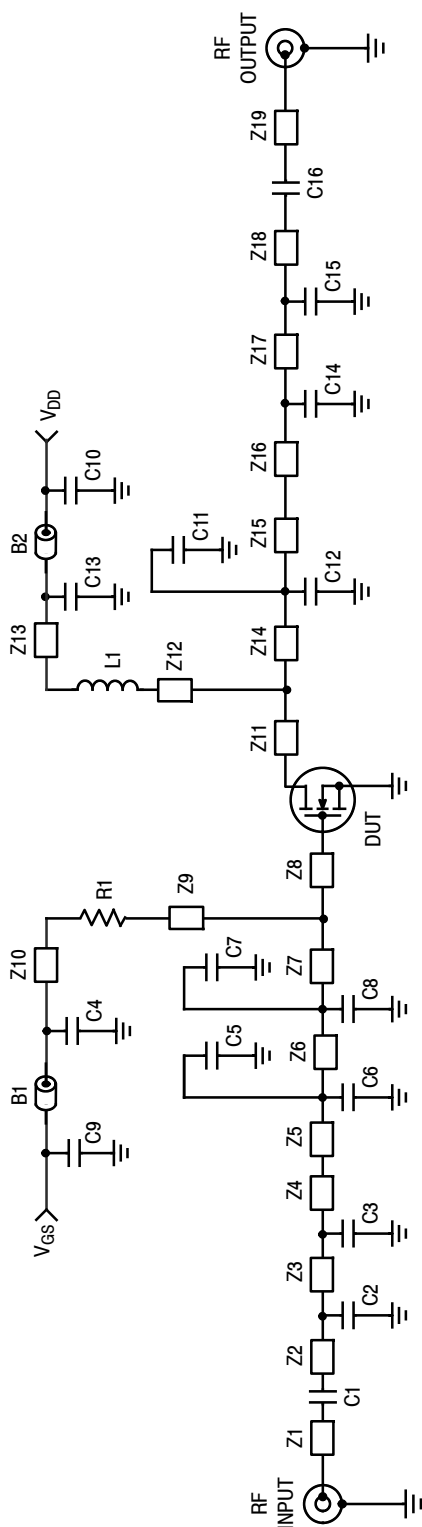
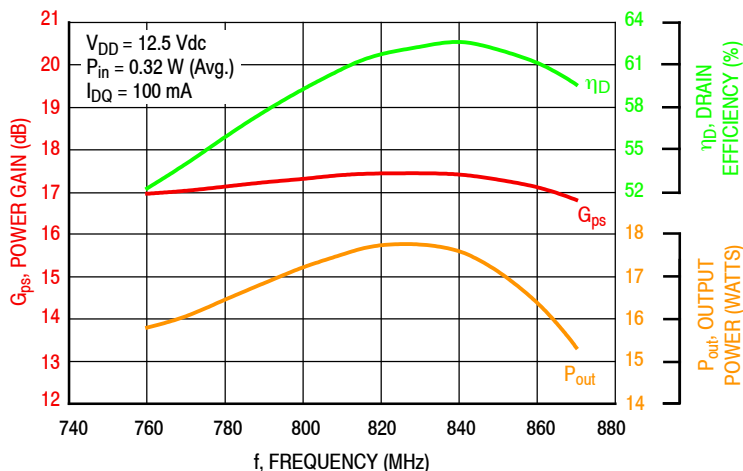


Figure 10. AFT09MS015NT1 UHF Broadband Reference Circuit Schematic — 760-870 MHz

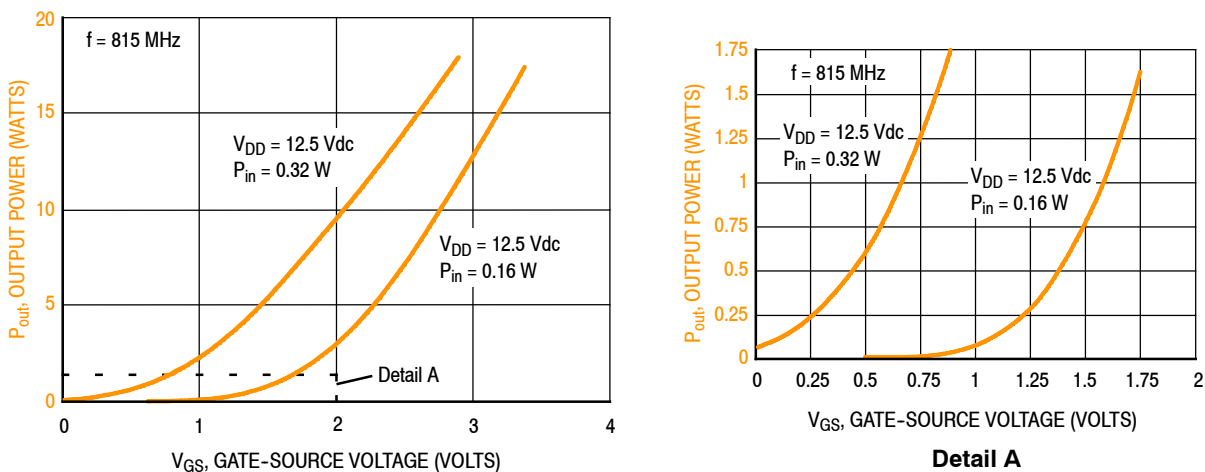
Table 11. AFT09MS015NT1 Narrowband Test Circuit Microstrips — 760-870 MHz

| Microstrip | Description                |
|------------|----------------------------|
| Z1         | 0.150" x 0.050" Microstrip |
| Z2         | 0.100" x 0.034" Microstrip |
| Z3         | 0.485" x 0.034" Microstrip |
| Z4         | 0.065" x 0.034" Microstrip |
| Z5         | 0.040" x 0.250" Microstrip |
| Z6         | 0.222" x 0.250" Microstrip |
| Z7         | 0.130" x 0.250" Microstrip |
| Z8         | 0.027" x 0.250" Microstrip |
| Z9         | 0.066" x 0.034" Microstrip |
| Z10        | 0.386" x 0.034" Microstrip |
| Z11        | 0.027" x 0.180" Microstrip |
| Z12        | 0.160" x 0.034" Microstrip |
| Z13        | 0.350" x 0.034" Microstrip |
| Z14        | 0.210" x 0.180" Microstrip |
| Z15        | 0.215" x 0.180" Microstrip |
| Z16        | 0.065" x 0.034" Microstrip |
| Z17        | 0.450" x 0.034" Microstrip |
| Z18        | 0.100" x 0.034" Microstrip |
| Z19        | 0.150" x 0.050" Microstrip |

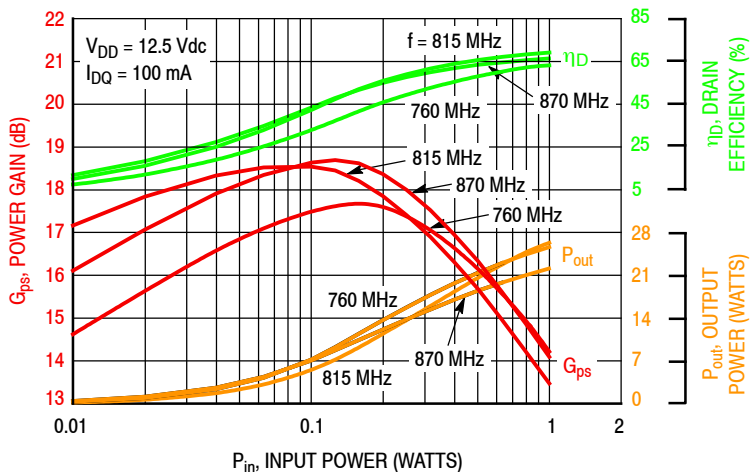
## TYPICAL CHARACTERISTICS — 760-870 MHz UHF BROADBAND REFERENCE CIRCUIT



**Figure 11. Power Gain, Drain Efficiency and Output Power versus Frequency at a Constant Input Power**

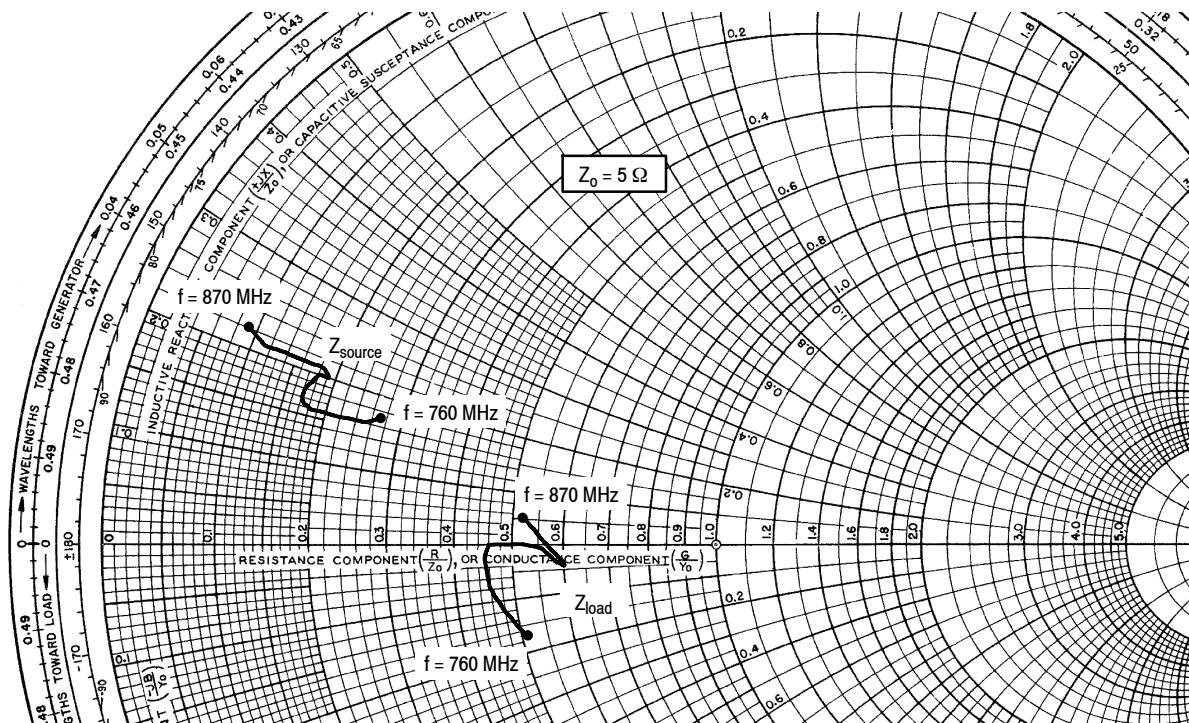


**Figure 12. Output Power versus Gate-Source Voltage**



**Figure 13. Power Gain, Drain Efficiency and Output Power versus Input Power and Frequency**

## 760-870 MHz UHF BROADBAND REFERENCE CIRCUIT



$V_{DD} = 12.5 \text{ Vdc}$ ,  $I_{DQ} = 100 \text{ mA}$ ,  $P_{out} = 15 \text{ W}$

| f<br>MHz | $Z_{source}$<br>$\Omega$ | $Z_{load}$<br>$\Omega$ |
|----------|--------------------------|------------------------|
| 760      | $1.35 + j0.86$           | $2.53 - j0.83$         |
| 770      | $1.23 + j0.79$           | $2.44 - j0.68$         |
| 780      | $1.04 + j0.78$           | $2.29 - j0.39$         |
| 790      | $0.90 + j0.80$           | $2.25 - j0.16$         |
| 800      | $0.84 + j0.84$           | $2.30 - j0.02$         |
| 810      | $0.85 + j0.92$           | $2.49 + j0.02$         |
| 820      | $0.92 + j0.99$           | $2.79 - j0.06$         |
| 830      | $0.96 + j1.02$           | $2.99 - j0.19$         |
| 840      | $0.88 + j1.03$           | $3.01 - j0.21$         |
| 850      | $0.71 + j1.04$           | $2.85 - j0.05$         |
| 860      | $0.54 + j1.05$           | $2.68 + j0.14$         |
| 870      | $0.43 + j1.10$           | $2.62 + j0.25$         |

$Z_{source}$  = Test circuit impedance as measured from gate to ground.

$Z_{load}$  = Test circuit impedance as measured from drain to ground.

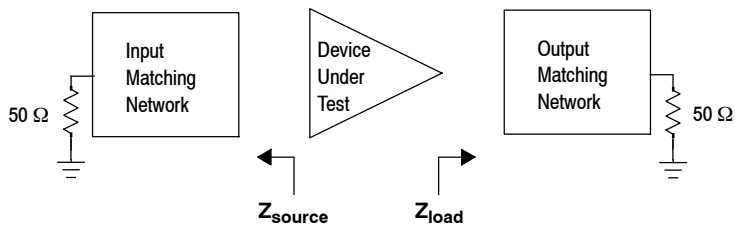


Figure 14. UHF Broadband Series Equivalent Source and Load Impedance — 760-870 MHz

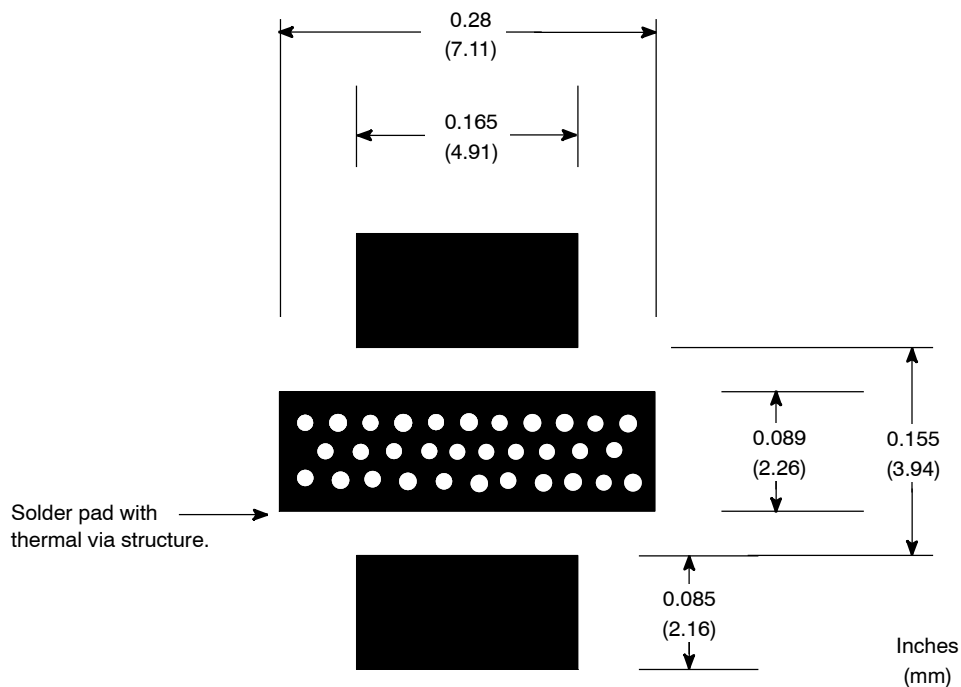


Figure 15. PCB Pad Layout for PLD-1.5W

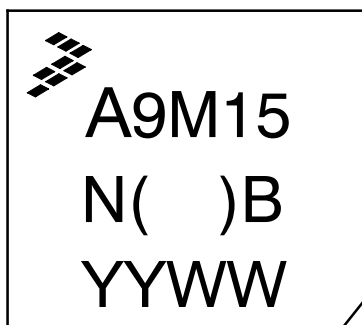
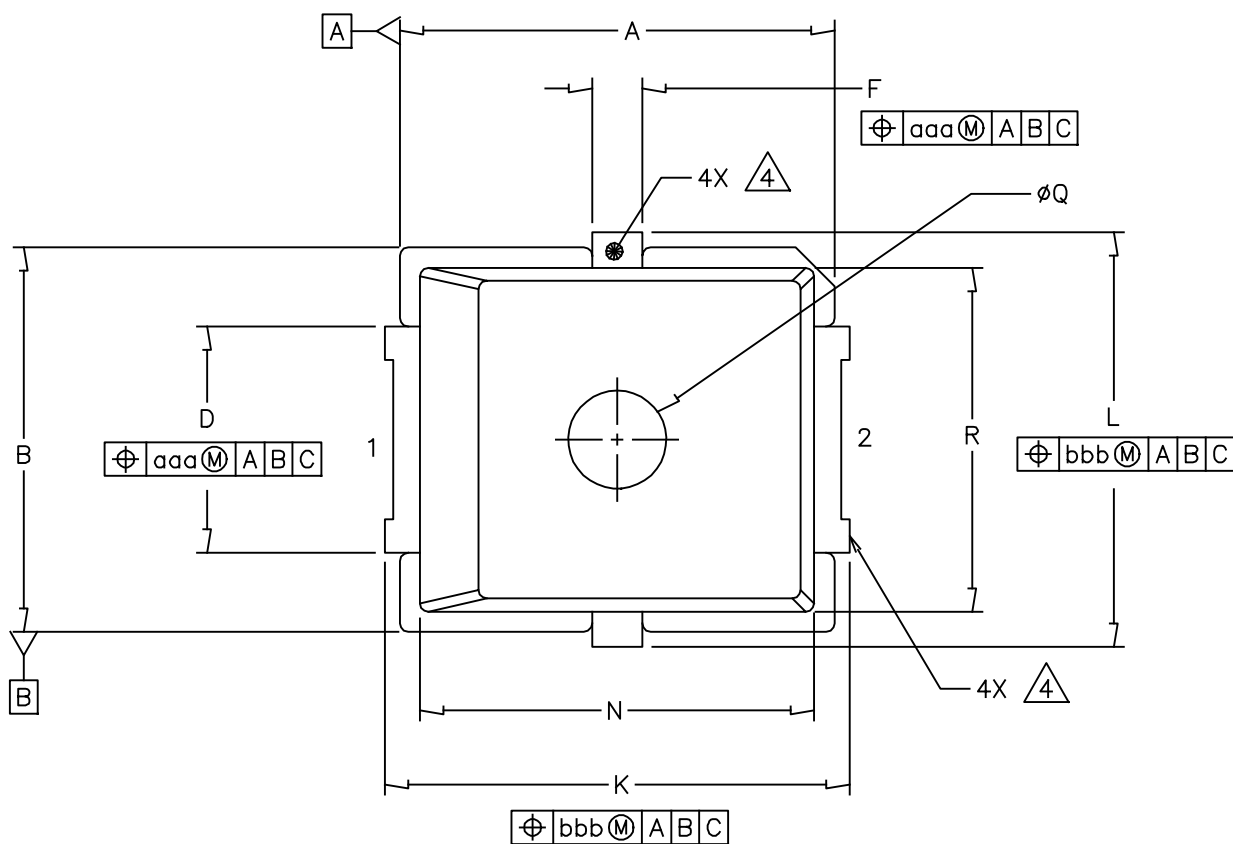
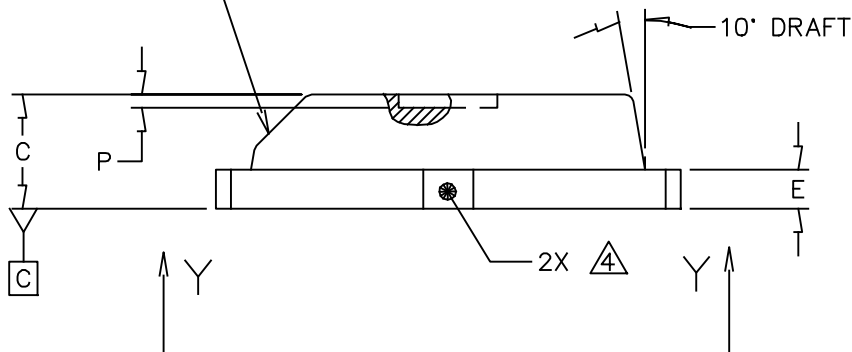


Figure 16. Product Marking

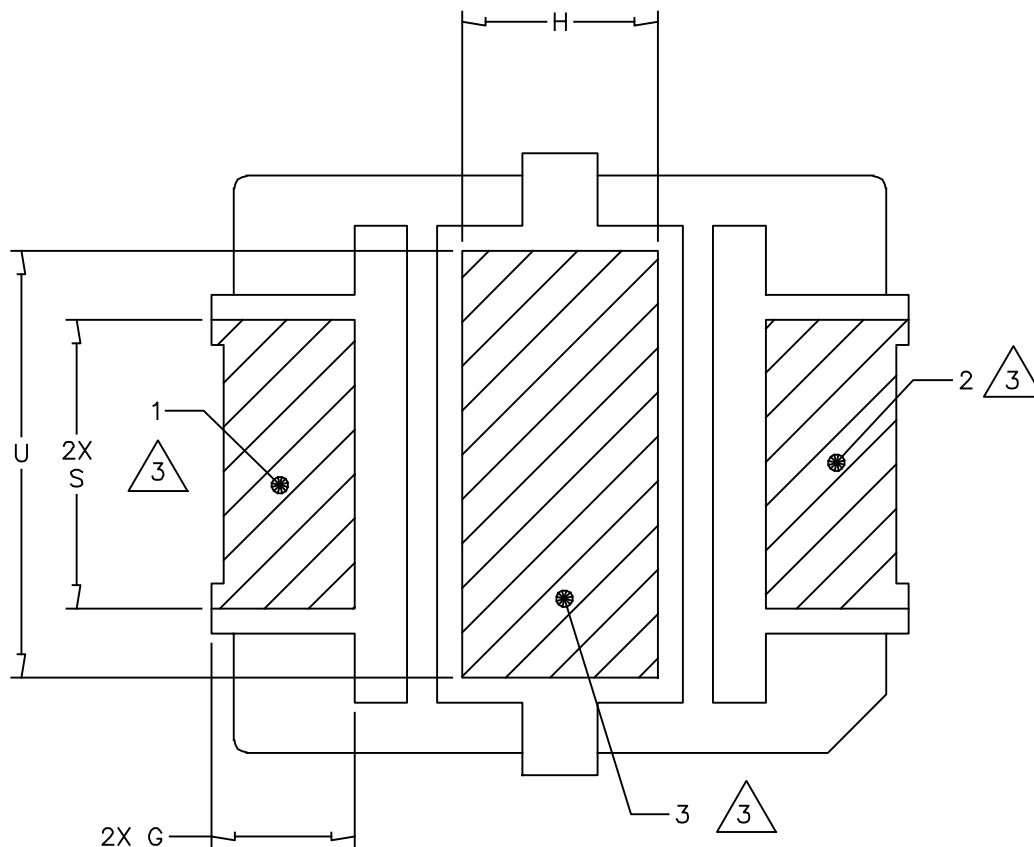
**PACKAGE DIMENSIONS**



.035(0.89) X 45°±5°



|   |                          |                            |  |
|---|--------------------------|----------------------------|--|
| © FREESCALE SEMICONDUCTOR, INC.<br>ALL RIGHTS RESERVED. | MECHANICAL OUTLINE       | PRINT VERSION NOT TO SCALE |  |
| TITLE:<br><br>PLD-1.5W                                  | DOCUMENT NO: 98ASA00476D | REV: 0                     |  |
|   | CASE NUMBER: 2297-01     | 14 JUN 2012                |  |
|   | STANDARD: NON-JEDEC      |                            |  |



VIEW Y-Y

|   |                          |                            |  |
|---|--------------------------|----------------------------|--|
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| TITLE:<br><br>PLD-1.5W                                  | DOCUMENT NO: 98ASA00476D | REV: 0                     |  |
|   | CASE NUMBER: 2297-01     | 14 JUN 2012                |  |
|   | STANDARD: NON-JEDEC      |                            |  |

NOTES:

1. CONTROLLING DIMENSION: INCH.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.

3. HATCHING REPRESENTS THE EXPOSED AND SOLDERABLE AREA. DIMENSIONS G, S, H AND U REPRESENT THE VALUES BETWEEN THE TWO OPPOSITE POINTS ALONG THE EDGES OF EXPOSED AREA.

4. THESE SURFACES ARE NOT PART OF THE SOLDERABLE SURFACES AND MAY REMAIN UNPLATED.

| DIM   | INCH |      | MILLIMETER         |      | DIM                      | INCH                       |      | MILLIMETER  |      |
|---|------|------|--------------------|------|--------------------------|----------------------------|------|-------------|------|
|   | MIN  | MAX  | MIN                | MAX  |                          | MIN                        | MAX  | MIN         | MAX  |
| A   | .255 | .265 | 6.48               | 6.73 | Q                        | .055                       | .063 | 1.40        | 1.60 |
| B   | .225 | .235 | 5.72               | 5.97 | R                        | .200                       | .210 | 5.08        | 5.33 |
| C   | .065 | .072 | 1.65               | 1.83 | S                        | .110                       | —    | 2.79        | —    |
| D   | .130 | .150 | 3.30               | 3.81 | U                        | .156                       | —    | 3.96        | —    |
| E   | .021 | .026 | 0.53               | 0.66 | aaa                      |                            | .004 |             | 0.10 |
| F   | .026 | .044 | 0.66               | 1.12 | bbb                      |                            | .005 |             | 0.13 |
| G   | .038 | —    | 0.97               | —    |                          |                            |      |             |      |
| H   | .069 | —    | 1.75               | —    |                          |                            |      |             |      |
| J   | .160 | .180 | 4.06               | 4.57 |                          |                            |      |             |      |
| K   | .273 | .285 | 6.93               | 7.24 |                          |                            |      |             |      |
| L   | .245 | .255 | 6.22               | 6.48 |                          |                            |      |             |      |
| N   | .230 | .240 | 5.84               | 6.10 |                          |                            |      |             |      |
| P   | .000 | .008 | 0.00               | 0.20 |                          |                            |      |             |      |
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| TITLE:<br><br>PLD-1.5W                                  |      |      |                    |      | DOCUMENT NO: 98ASA00476D |                            |      | REV: 0      |      |
|   |      |      |                    |      | CASE NUMBER: 2297-01     |                            |      | 14 JUN 2012 |      |
|   |      |      |                    |      | STANDARD: NON-JEDEC      |                            |      |             |      |



Refer to the following resources to aid your design process.

**Application Notes**

- AN1907: Solder Reflow Attach Method for High Power RF Devices in Over-Molded Plastic Packages
- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

**Engineering Bulletins**

- EB212: Using Data Sheet Impedances for RF LDMOS Devices

**Software**

- Electromigration MTTF Calculator
- RF High Power Model
- .s2p File

**Development Tools**

- Printed Circuit Boards

For Software and Tools, do a Part Number search at <http://www.freescale.com>, and select the “Part Number” link. Go to the Software & Tools tab on the part’s Product Summary page to download the respective tool.

**REVISION HISTORY**

The following table summarizes revisions to this document.

| Revision | Date      | Description   |
|----------|-----------|---|
| 0        | Feb. 2014 | <ul style="list-style-type: none"> <li>• Initial Release of Data Sheet</li> </ul>   |
| 1        | July 2014 | <ul style="list-style-type: none"> <li>• Fig. 6, Output Power versus Gate-Source Voltage at a Constant Input Power: updated <math>P_{in}</math> values to reflect correct unit of measure, p. 7</li> <li>• Fig. 8, Narrowband Series Equivalent Source and Load Impedance - 870 MHz: updated <math>Z_{source}</math> and <math>Z_{load}</math> values to match final data from product model, p. 7</li> </ul> |

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